



# THE DATASHEET OF TLE6220GP





# Smart Quad Low-Side Switch

## Features

- Short Circuit Protection
- Overtemperature Protection
- Overvoltage Protection
- 8 bit Serial Data Input and Diagnostic Output (SPI protocol)
- Direct Parallel Control of Four Channels for PWM Applications
- Cascadable with Other Quad Switches
- Low Quiescent Current
- $\mu$ C Compatible Input
- **Electrostatic Discharge (ESD) Protection**
- Green Product (RoHS compliant)
- AEC qualified

## Product Summary

|  |                  |           |          |
|--|------------------|-----------|----------|
| Supply voltage                                     | $V_S$            | 4.5 – 5.5 | V        |
| Drain source voltage                               | $V_{DS(AZ) max}$ | 60        | V        |
| On resistance                                      | $R_{ON}$         | 0.32      | $\Omega$ |
| Output current (all outp. ON equal) (individually) | $I_{D(NOM)}$     | 1<br>3    | A<br>A   |

## Application

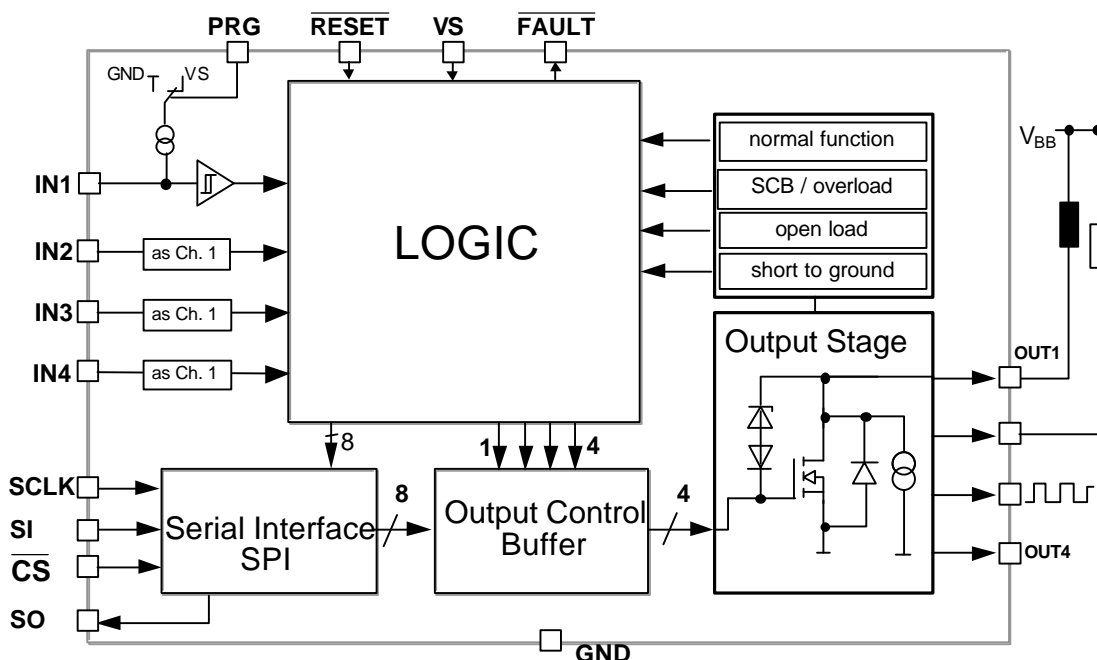
- $\mu$ C Compatible Power Switch for 12 V and 24 V Applications
- Switch for Automotive and Industrial System
- Solenoids, Relays and Resistive Loads
- Injectors
- Robotic controls



## General Description

Quad Low-Side Switch in Smart Power Technology (SPT) with a **Serial Peripheral Interface (SPI)** and four open drain DMOS output stages. The TLE 6220 GP is protected by embedded protection functions and designed for automotive and industrial applications. The output stages can be controlled direct in parallel for PWM applications (injector coils), or through serial control via the SPI. Therefore the TLE 6220 GP is particularly suitable for engine management and powertrain systems.

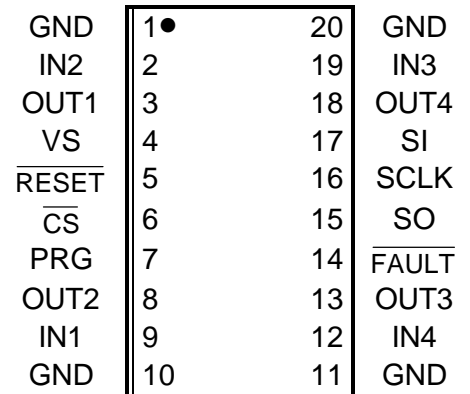
## Block Diagram



Pin Description

| Pin | Symbol                    | Function                            |
|-----|---------------------------|-------------------------------------|
| 1   | GND                       | Ground                              |
| 2   | IN2                       | Input Channel 2                     |
| 3   | OUT1                      | Power Output Channel 1              |
| 4   | VS                        | Supply Voltage                      |
| 5   | $\overline{\text{RESET}}$ | Reset                               |
| 6   | $\overline{\text{CS}}$    | Chip Select                         |
| 7   | PRG                       | Program (inputs high or low active) |
| 8   | OUT2                      | Power Output Channel 2              |
| 9   | IN1                       | Input Channel 1                     |
| 10  | GND                       | Ground                              |
| 11  | GND                       | Ground                              |
| 12  | IN4                       | Input Channel 4                     |
| 13  | OUT3                      | Power Output Channel 3              |
| 14  | $\overline{\text{FAULT}}$ | General Fault Flag                  |
| 15  | SO                        | Serial Data Output                  |
| 16  | SCLK                      | Serial Clock                        |
| 17  | SI                        | Serial Data Input                   |
| 18  | OUT4                      | Power Output Channel 4              |
| 19  | IN3                       | Input Channel 3                     |
| 20  | GND                       | Ground                              |

Pin Configuration (Top view)

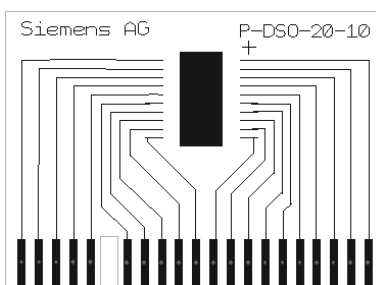


Power SO-20

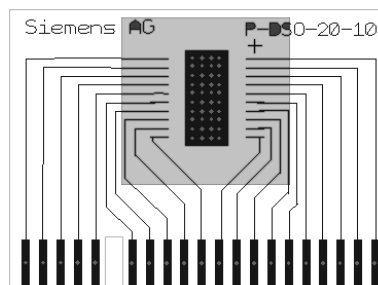
Heat slug internally connected to ground pins

**Maximum Ratings for  $T_j = -40^{\circ}\text{C}$  to  $150^{\circ}\text{C}$** 

| Parameter   | Symbol                   | Values            | Unit               |
|---|--------------------------|-------------------|--------------------|
| Supply Voltage  | $V_S$                    | -0.3 ... +7       | V                  |
| Continuous Drain Source Voltage (OUT1...OUT4)   | $V_{DS}$                 | 45                | V                  |
| Input Voltage, All Inputs and Data Lines  | $V_{IN}$                 | - 0.3 ... + 7     | V                  |
| Load Dump Protection $V_{Load\ Dump} = U_P + U_S$ ; $U_P = 13.5\text{ V}$<br>With Automotive Injector Valve $R_L = 14\ \Omega$<br>$R_l^1) = 2\ \Omega$ ; $t_d = 400\text{ms}$ ; IN = low or high<br>With $R_L = 6.8\ \Omega$ ( $I_D = 2\text{A}$ )<br>$R_l = 2\ \Omega$ ; $t_d = 400\text{ms}$ ; IN = low or high | $V_{Load\ Dump}^{2)}$    | 62<br>52          | V                  |
| Operating Temperature Range   | $T_j$                    | - 40 ... + 150    | $^{\circ}\text{C}$ |
| Storage Temperature Range   | $T_{stg}$                | - 55 ... + 150    | $^{\circ}\text{C}$ |
| Output Current per Channel (see el. characteristics)  | $I_{D(lim)}$             | $I_{D(lim)\ min}$ | A                  |
| Output Current per Channel @ $T_A = 25^{\circ}\text{C}$<br>(All 4 Channels ON; Mounted on PCB ) <sup>3)</sup>   | $I_D$                    | 1                 | A                  |
| Output Clamping Energy<br>$I_D = 1\text{A}$   | $E_{AS}$                 | 50                | mJ                 |
| Power Dissipation (DC, mounted on PCB) @ $T_A = 25^{\circ}\text{C}$   | $P_{tot}$                | 3                 | W                  |
| Electrostatic Discharge Voltage (human body model)<br>according to MIL STD 883D, method 3015.7 and EOS/ESD<br>asn. standard S5.1 - 1993   | $V_{ESD}$                | 2000              | V                  |
| DIN Humidity Category, DIN 40 040   |                          | E                 |                    |
| IEC Climatic Category, DIN IEC 68-1   |                          | 40/150/56         |                    |
| Thermal resistance<br>junction – case (die soldered on the frame)<br>junction - ambient @ min. footprint<br>junction - ambient @ $6\text{ cm}^2$ cooling area   | $R_{thJC}$<br>$R_{thJA}$ | 2<br>50<br>38     | K/W                |



Minimum footprint


 PCB with heat pipes,  
backside  $6\text{ cm}^2$  cooling area

1)  $R_l$  = internal resistance of the load dump test pulse generator LD200

2)  $V_{LoadDump}$  is setup without DUT connected to the generator per ISO 7637-1 and DIN 40 839.

3) Output current rating so long as maximum junction temperature is not exceeded. At  $T_A = 125^{\circ}\text{C}$  the output current has to be calculated using  $R_{thJA}$  according mounting conditions.

## Electrical Characteristics

| Parameter and Conditions<br>$V_S = 4.5$ to $5.5$ V ; $T_J = -40$ °C to $+150$ °C ; Reset = H<br>(unless otherwise specified) | Symbol | Values |     |     | Unit |
|--|--------|--------|-----|-----|------|
|  |        | min    | typ | max |      |

### 1. Power Supply, Reset

|   |                        |     |    |     |               |
|---|------------------------|-----|----|-----|---------------|
| Supply Voltage <sup>4</sup>   | $V_S$                  | 4.5 | -- | 5.5 | V             |
| Supply Current <sup>5</sup>   | $I_S$                  | --  | 1  | 2   | mA            |
| Minimum Reset Duration<br>(After a reset all parallel inputs are ORed with the SPI data bits) | $t_{\text{Reset,min}}$ | 10  |    |     | $\mu\text{s}$ |

### 2. Power Outputs

|   |   |                     |    |            |            |               |
|---|---|---------------------|----|------------|------------|---------------|
| ON Resistance $V_S = 5$ V ; $I_D = 1$ A | $T_J = 25^\circ\text{C}$<br>$T_J = 150^\circ\text{C}$ | $R_{\text{DS(ON)}}$ | -- | 0.32<br>-- | 0.4<br>0.7 | $\Omega$      |
| Output Clamping Voltage                 | output OFF  | $V_{\text{DS(AZ)}}$ | 45 | 53         | 60         | V             |
| Current Limit                           |   | $I_{\text{D(lim)}}$ | 3  | 4.5        | 6          | A             |
| Output Leakage Current                  | $V_{\text{RESET}} = \text{L}$                         | $I_{\text{D(Ikg)}}$ | -- | --         | 10         | $\mu\text{A}$ |
| Turn-On Time                            | $I_D = 1$ A, resistive load                           | $t_{\text{ON}}$     | -- | 5          | 10         | $\mu\text{s}$ |
| Turn-Off Time                           | $I_D = 1$ A, resistive load                           | $t_{\text{OFF}}$    | -- | 5          | 10         | $\mu\text{s}$ |

### 3. Digital Inputs

|  |  |                          |       |     |             |               |
|--|--|--------------------------|-------|-----|-------------|---------------|
| Input Low Voltage                                |  | $V_{\text{INL}}$         | - 0.3 | --  | 1.0         | V             |
| Input High Voltage                               |  | $V_{\text{INH}}$         | 2.0   | --  | $V_S + 0.3$ | V             |
| Input Voltage Hysteresis                         |  | $V_{\text{INHys}}$       | 50    | 100 | 200         | mV            |
| Input Pull Down/Up Current (IN1 ... IN4)         |  | $I_{\text{IN(1..4)}}$    | 20    | 50  | 100         | $\mu\text{A}$ |
| PRG, RESET Pull Up Current                       |  | $I_{\text{IN(PRG,Res)}}$ | 20    | 50  | 100         | $\mu\text{A}$ |
| Input Pull Down Current (SI, SCLK)               |  | $I_{\text{IN(SI,SCLK)}}$ | 10    | 20  | 50          | $\mu\text{A}$ |
| Input Pull Up Current ( $\overline{\text{CS}}$ ) |  | $I_{\text{IN(CS)}}$      | 10    | 20  | 50          | $\mu\text{A}$ |

### 4. Digital Outputs (SO, FAULT)

|  |   |                           |             |     |     |                  |
|--|---|---------------------------|-------------|-----|-----|------------------|
| SO High State Output Voltage                   | $I_{\text{SOH}} = 2$ mA   | $V_{\text{SOH}}$          | $V_S - 0.4$ | --  | --  | V                |
| SO Low State Output Voltage                    | $I_{\text{SOL}} = 2.5$ mA   | $V_{\text{SOL}}$          | --          | --  | 0.4 | V                |
| Output Tri-state Leakage Current               | $\overline{\text{CS}} = \text{H}$ , $0 \leq V_{\text{SO}} \leq V_S$ | $I_{\text{SOIkg}}$        | -10         | 0   | 10  | $\mu\text{A}$    |
| FAULT Output Low Voltage                       | $I_{\text{FAULT}} = 1.6$ mA   | $V_{\text{FAULTL}}$       | --          | --  | 0.4 | V                |
| Current Limitation; Overload Threshold Current |   | $I_{\text{D(lim) 1...4}}$ | 3           | 4.5 | 6   | A                |
| Overtemperature Shutdown Threshold             |   | $T_{\text{th(sd)}}$       | 170         | --  | 200 | $^\circ\text{C}$ |
| Hysteresis <sup>6</sup>                        |   | $T_{\text{hys}}$          | --          | 10  | --  | K                |

<sup>4</sup> For  $V_S < 4.5$  V the power stages are switched according the input signals and data bits or are definitely switched off. This undervoltage reset gets active at  $V_S = 3$  V (typ. value) and is guaranteed by design.

<sup>5</sup> If Reset = L the supply current is reduced to typ. 20 $\mu\text{A}$

<sup>6</sup> This parameter will not be tested but guaranteed by design

**Electrical Characteristics cont.**

| Parameter and Conditions<br>$V_S = 4.5$ to $5.5$ V ; $T_j = -40$ °C to $+150$ °C ; Reset = H<br>(unless otherwise specified) | Symbol | Values |     |     | Unit |
|--|--------|--------|-----|-----|------|
|  |        | min    | typ | max |      |

**5. Diagnostic Functions**

|                                   |                |             |             |             |         |
|-----------------------------------|----------------|-------------|-------------|-------------|---------|
| Open Load Detection Voltage       | $V_{DS(OL)}$   | $V_S - 2.5$ | $V_S - 2$   | $V_S - 1.3$ | V       |
| Output Pull Down Current          | $I_{PD(OL)}$   | 50          | 90          | 150         | $\mu$ A |
| Fault Delay Time                  | $t_{d(fault)}$ | 50          | 110         | 200         | $\mu$ s |
| Short to Ground Detection Voltage | $V_{DS(SHG)}$  | $V_S - 3.3$ | $V_S - 2.9$ | $V_S - 2.5$ | V       |
| Short to Ground Detection Current | $I_{SHG}$      | -50         | -100        | -150        | $\mu$ A |

**6. SPI-Timing**

|   |                             |     |     |     |     |
|---|-----------------------------|-----|-----|-----|-----|
| Serial Clock Frequency (depending on SO load)   | $f_{SCK}$                   | DC  | --  | 5   | MHz |
| Serial Clock Period (1/fclk)  | $t_{p(SCK)}$                | 200 | --  | --  | ns  |
| Serial Clock High Time  | $t_{SCKH}$                  | 50  | --  | --  | ns  |
| Serial Clock Low Time   | $t_{SCKL}$                  | 50  | --  | --  | ns  |
| Enable Lead Time (falling edge of $\overline{CS}$ to rising edge of CLK)              | $t_{lead}$                  | 250 | --  | --  | ns  |
| Enable Lag Time (falling edge of CLK to rising edge of $\overline{CS}$ )              | $t_{lag}$                   | 250 | --- | --  | ns  |
| Data Setup Time (required time SI to falling of CLK)                                  | $t_{SU}$                    | 20  | --  | --  | ns  |
| Data Hold Time (falling edge of CLK to SI)  | $t_{H}$                     | 20  | --  | --  | ns  |
| Disable Time @ $C_L = 50$ pF <sup>8</sup>   | $t_{DIS}$                   | --  | --  | 150 | ns  |
| Transfer Delay Time <sup>7</sup><br>( $\overline{CS}$ high time between two accesses) | $t_{dt}$                    | 200 | --  | --  | ns  |
| Data Valid Time   | $t_{valid}$                 |     |     |     |     |
|   | $C_L = 50$ pF               | --  | --  | 110 | ns  |
|   | $C_L = 100$ pF <sup>8</sup> | --  | --  | 120 |     |
|   | $C_L = 220$ pF <sup>8</sup> | --  | --  | 150 |     |

<sup>7</sup> This time is necessary between two write accesses. To get the correct diagnostic information, the transfer delay time has to be extended to the maximum fault delay time  $t_{d(fault)max} = 200\mu$ s.

<sup>8</sup> This parameter will not be tested but guaranteed by design

## Functional Description

The TLE 6220 GP is an quad-low-side power switch which provides a serial peripheral interface (SPI) to control the 4 power DMOS switches, as well as diagnostic feedback. The power transistors are protected against short to  $V_{BB}$ , overload, overtemperature and against over-voltage by an active zener clamp.

The diagnostic logic recognises a fault condition which can be read out via the serial diagnostic output (SO).

## Circuit Description

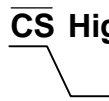
### Power Transistor Protection Functions<sup>9)</sup>


Each of the four output stages has its own zener clamp, which causes a voltage limitation at the power transistor when solenoid loads are switched off. The outputs are provided with a current limitation set to a minimum of 3 A. The continuous current for each channel is 1A (all channels ON; depending on cooling).

Each output is protected by embedded protection functions. In the event of an overload or short to supply, the current is internally limited and the corresponding bit combination is set (early warning). If this operation leads to an overtemperature condition, a second protection level (about 170 °C) will change the output into a low duty cycle PWM (selective thermal shut-down with restart) to prevent critical chip temperatures.

### SPI Signal Description

$\overline{CS}$  - Chip Select. The system microcontroller selects the TLE 6220 GP by means of the  $\overline{CS}$  pin. Whenever the pin is in a logic low state, data can be transferred from the  $\mu C$  and vice versa.

$\overline{CS}$  High to Low transition:  - Diagnostic status information is transferred from the power outputs into the shift register.  
 - Serial input data can be clocked in from then on.  
 - SO changes from high impedance state to logic high or low state corresponding to the SO bits.

$\overline{CS}$  Low to High transition:  - Transfer of SI bits from shift register into output buffers  
 - Reset of diagnosis register.

To avoid any false clocking the serial clock input pin SCLK should be logic low state during high to low transition of  $\overline{CS}$ . When  $\overline{CS}$  is in a logic high state, any signals at the SCLK and SI pins are ignored and SO is forced into a high impedance state.

<sup>9)</sup> The integrated protection functions prevent an IC destruction under fault conditions and may not be used in normal operation or permanently.

**SCLK** - Serial Clock. The system clock pin clocks the internal shift register of the TLE 6220 GP. The serial input (SI) accepts data into the input shift register on the falling edge of SCLK while the serial output (SO) shifts diagnostic information out of the shift register on the rising edge of serial clock. It is essential that the SCLK pin is in a logic low state whenever chip select  $\overline{CS}$  makes any transition.

**SI** - Serial Input. Serial data bits are shifted in at this pin, the most significant bit first. SI information is read in on the falling edge of SCLK. Input data is latched in the shift register and then transferred to the control buffer of the output stages.

The input data consists of one byte, made up of four control bits and four data bits. The control word is used to program the device, to operate it in a certain mode as well as providing diagnostic information (see page 11). The four data bits contain the input information for the four channels, and are high active.

**SO** - Serial Output. Diagnostic data bits are shifted out serially at this pin, the most significant bit first. SO is in a high impedance state until the  $\overline{CS}$  pin goes to a logic low state. New diagnostic data will appear at the SO pin following the rising edge of SCLK.

**$\overline{RESET}$**  - Reset pin. If the reset pin is in a logic low state, it clears the SPI shift register and switches all outputs OFF. An internal pull-up structure is provided on chip. As long as the reset pin is low the device is in low quiescent current mode and the supply current is reduced to typ. 20 $\mu$ A.

## Output Stage Control

The four outputs of the TLE 6220 GP can either be controlled in parallel (IN1...IN4), or via the Serial Peripheral Interface (SPI).

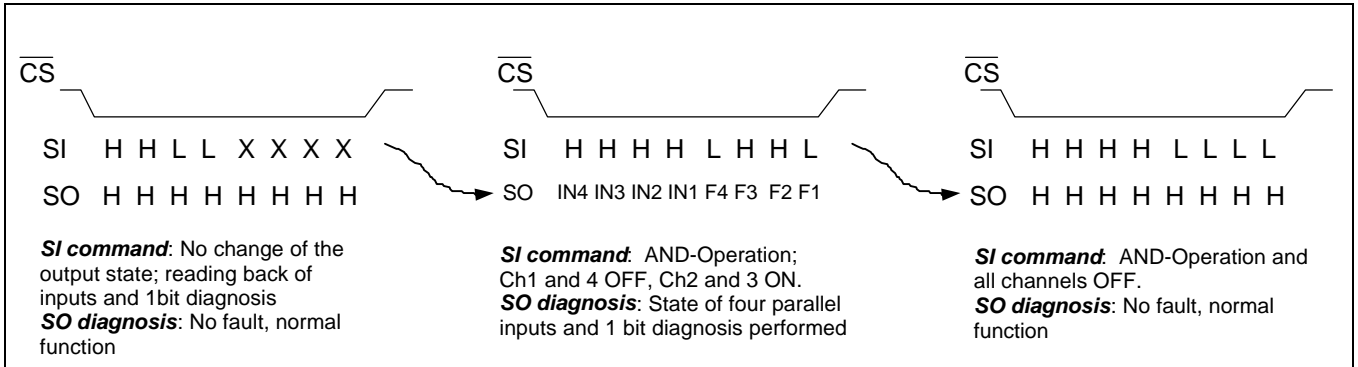
### Parallel Control

A Boolean operation (either AND or OR) is performed on each of the parallel inputs and respective SPI data bits, in order to determine the states of the respective outputs. The type of Boolean operation performed is programmed via the serial interface.

The parallel inputs are high or low active depending on the PRG pin. If the parallel input pins are not connected (independent of high or low activity) it is guaranteed that the outputs 1 to 4 are switched OFF. PRG pin itself is internally pulled up when it is not connected.

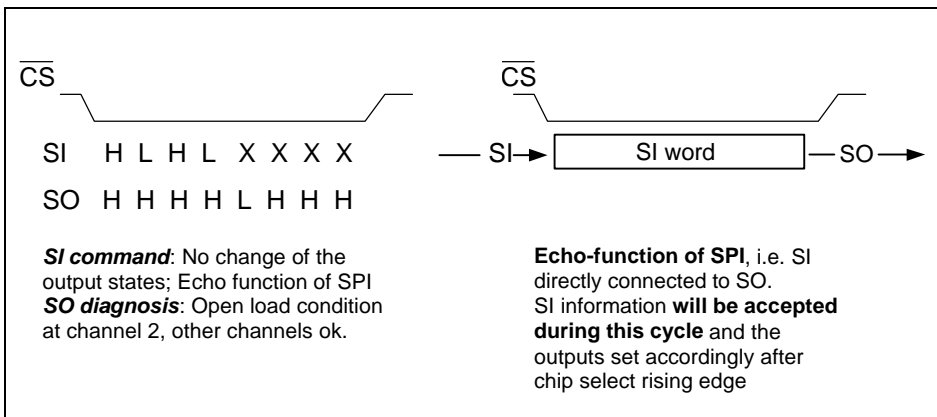
**PRG** - Program pin.      PRG = High ( $V_S$ ): Parallel inputs Channel 1 to 4 are high active  
PRG = Low (GND): Parallel inputs Channel 1 to 4 are low active.





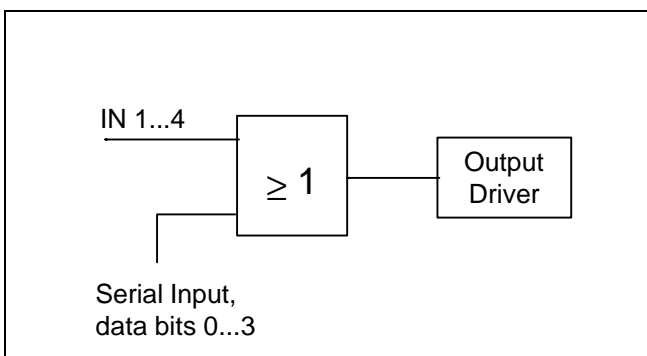
### 3. HLHL XXXX - Echo-function of SPI

To check the proper function of the serial interface the TLE 6220 GP provides a "SPI Echo Function". By entering HLHL as control word, SI and SO are connected during the next  $\overline{CS}$  period. By comparing the bits clocked in with the serial output bits, the proper function of the SPI interface can be verified. This internal loop is only closed once (for one  $\overline{CS}$  period).



### 4. LLHH DDDD - OR operation, and 'full diagnosis'

With LLHH as the control word, each of the input signals IN1...IN4 are 'OR'ed with the corresponding data bits (DDDD).



This OR operation enables the serial interface to switch the channel ON, even though the corresponding parallel input might be in the off state.

#### ▷ SPI Priority for ON-State

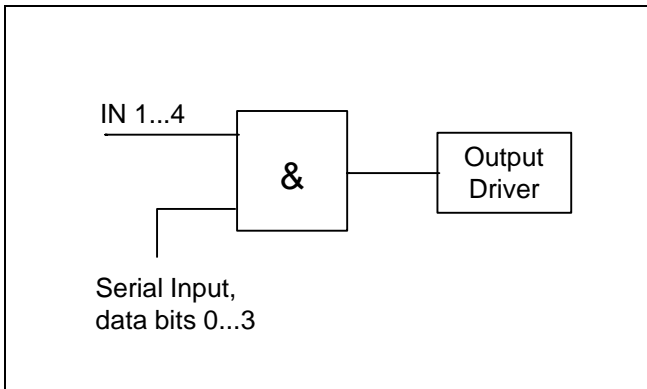
Also parallel control of the outputs is possible without an SPI input.

The OR-function is the default Boolean operation if the device restarts after a Reset, or when the supply voltage is switched on for the first time.

If the OR operation is programmed it is latched until it is overwritten by the AND operation.

5. **HHHH DDDD** - AND operation, and 'full diagnosis'

With HHHH as the control word, each of the input signals IN1...IN4 are 'AND'ed with the corresponding data bits (DDDD).



The AND operation implies that the output can be switched off by the SPI data bit input, even if the corresponding parallel input is in the ON state.

⇒ **SPI Priority for OFF-state**

This also implies that the serial input data bit can only switch the output channel ON if the corresponding parallel input is in the ON state.

If the AND operation is programmed it is latched until it is overwritten by the OR operation.

**Control words beside No. 1- 5**

All control words except those for Diag Only, Read Back of Inputs, SPI echo, will be accepted as an OR or an AND command with valid data bits depending on the boolean operation which was programmed before.

*Example 1:*

LLHH HLLH: OR operation between parallel inputs and data bits, i.e channel 1 and 4 will be switched on.

The next command is now: **LHHH HHLH**

LHHH as command word has no special meaning but it will be accepted as an OR operation and the data bits will be ORed with the inputs and the outputs 1,3 and 4 will be switched on. See above: 'If the OR operation is programmed it is latched until it is overwritten by the AND operation.'

*Example 2:*

HHHH LLHL means: Data bits will be ANDed with the parallel inputs and the outputs switch accordingly. Then **HLLH HHLH** is clocked in: AND was latched by the command before and is now valid again by using the HLLH command word. So the data bits will be accepted and again ANDed with the parallel input signals.

See above: 'If the AND operation is programmed it is latched until it is overwritten by the OR operation.'

## Diagnostics

**FAULT** - Fault pin. There is a general fault pin (open drain) which shows a high to low transition as soon as an error occurs for any one of the four channels. This fault indication can be used to generate a  $\mu$ C interrupt. Therefore a 'diagnosis' interrupt routine need only be called after this fault indication. This saves processor time compared to a cyclic reading of the SO information.

As soon as a fault occurs, the fault information is latched into the diagnosis register. A new error will over-write the old error report. Serial data out pin (SO) is in a high impedance state when  $\overline{CS}$  is high. If  $\overline{CS}$  receives a LOW signal, all diagnosis bits can be shifted out serially. The rising edge of  $\overline{CS}$  will reset all error registers.

### Full Diagnosis

For full diagnosis there are two diagnostic bits per channel configured as shown in Figure 1.

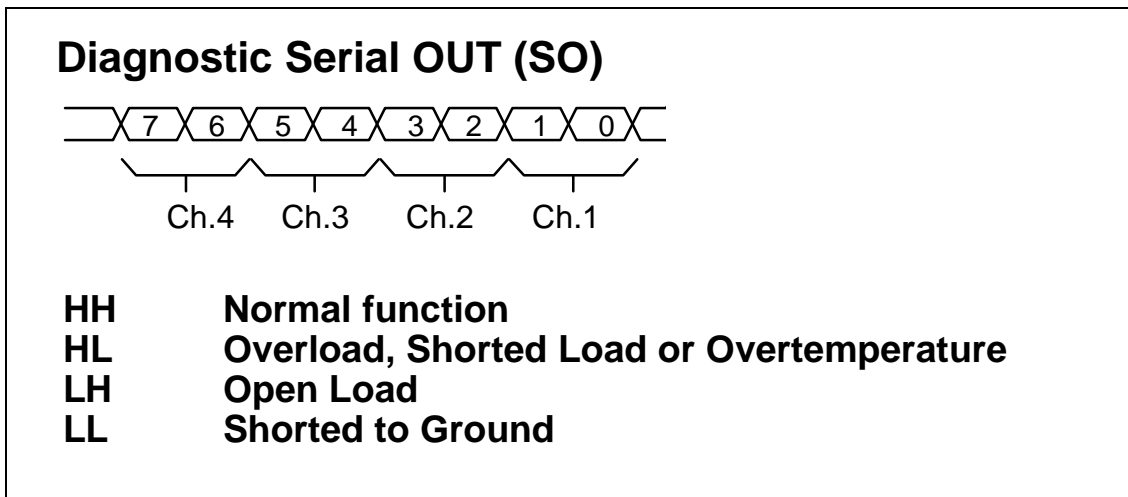


Figure 1: Two bits per channel diagnostic feedback

**Normal function:** The bit combination **HH** indicates that there is no fault condition, i.e. normal function.

**Overload, Short Circuit to Battery (SCB) or Overtemperature:** **HL** is set when the current limitation gets active, i.e. there is an overload, short to supply or overtemperature condition.

**Open load:** An open load condition is detected when the drain voltage decreases below 3 V (typ.). **LH** bit combination is set.

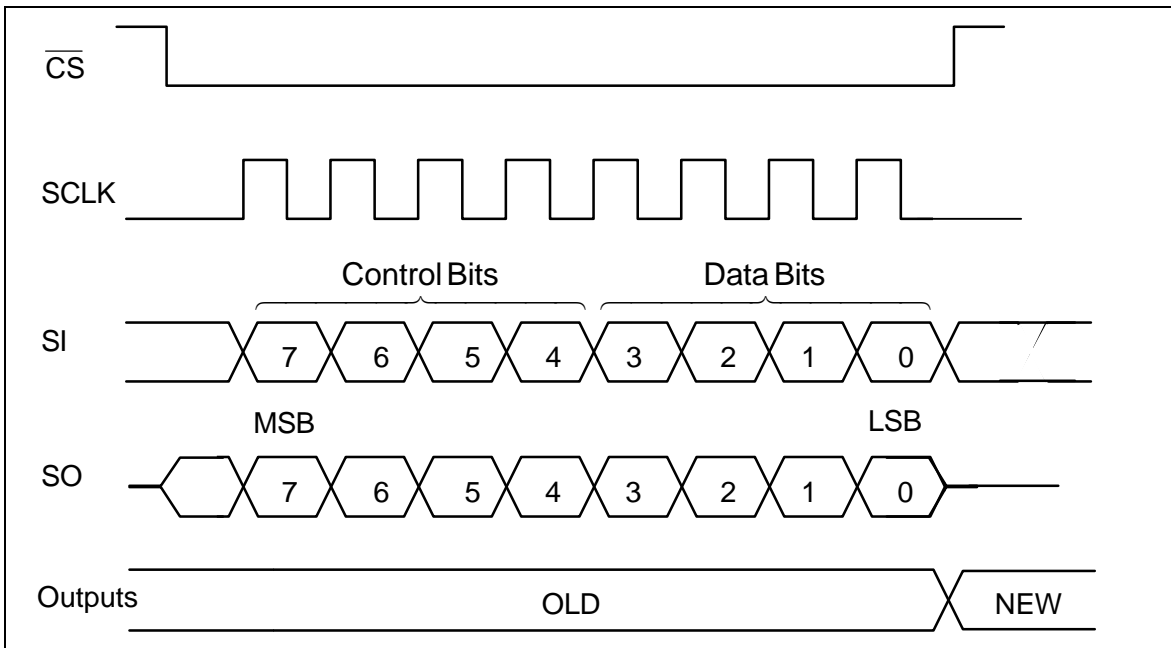
**Short Circuit to GND:** If a drain to ground short circuit exists and the drain to ground current exceeds 100  $\mu$ A, short to ground is detected and the **LL** bit combination is set.

A definite distinction between open load and short to ground is guaranteed by design.

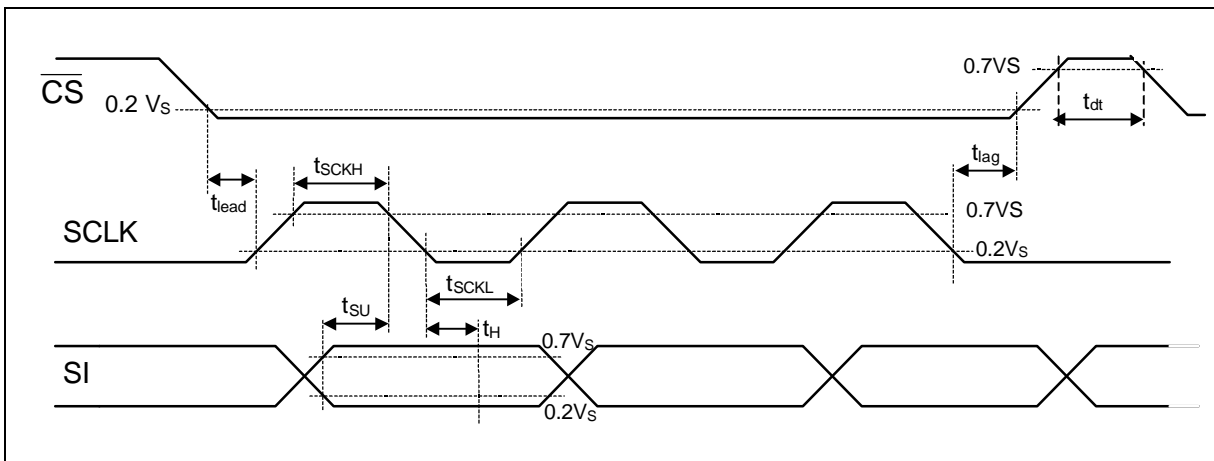
The standard way of obtaining diagnostic information is as follows:

Clock in serial information into SI pin and wait approximately 150  $\mu$ s to allow the outputs to settle. Clock in the identical serial information once again - during this process the data coming out at SO contains the bit combinations representing the diagnosis conditions as described in Figure 1.

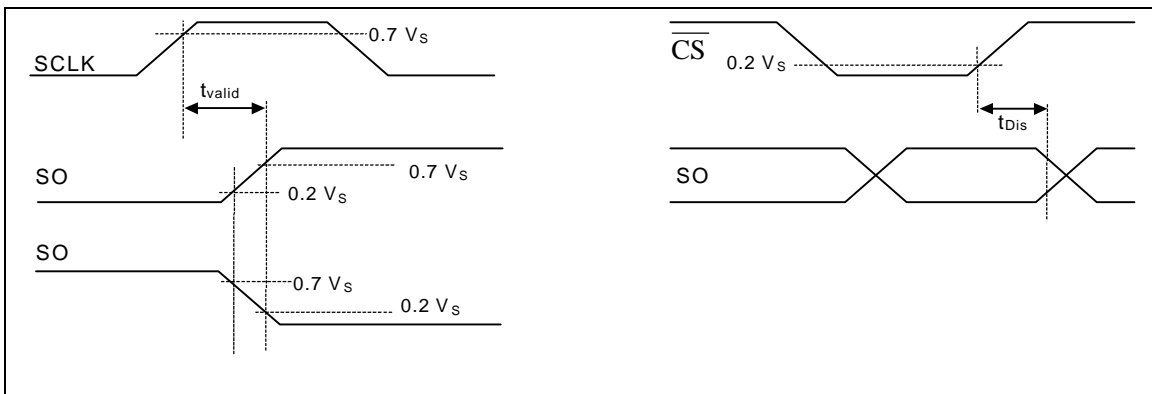
### Timing Diagrams



**Figure 2: Serial Interface**



**Figure 3: Input Timing Diagram**



**Figure 4: SO Valid Time Waveforms**

**Enable and Disable Time Waveforms**

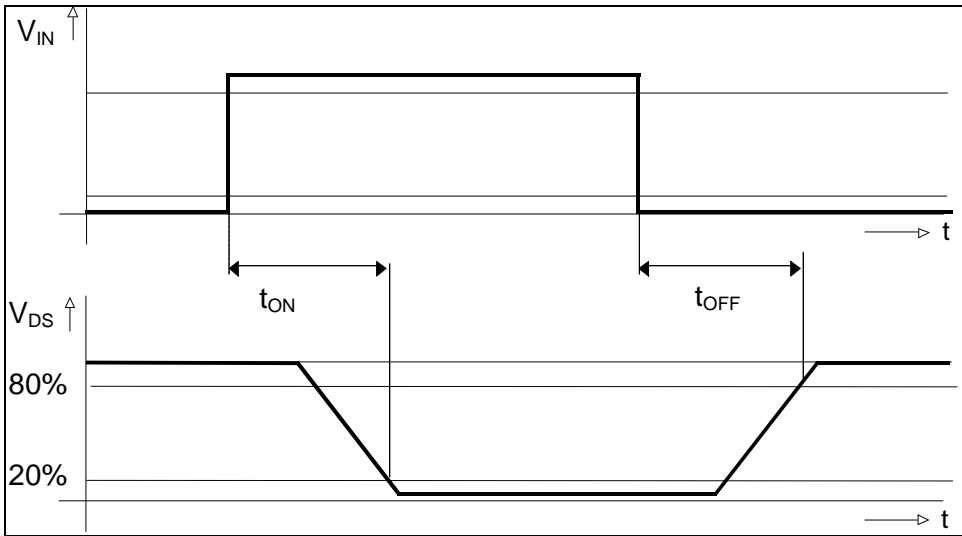
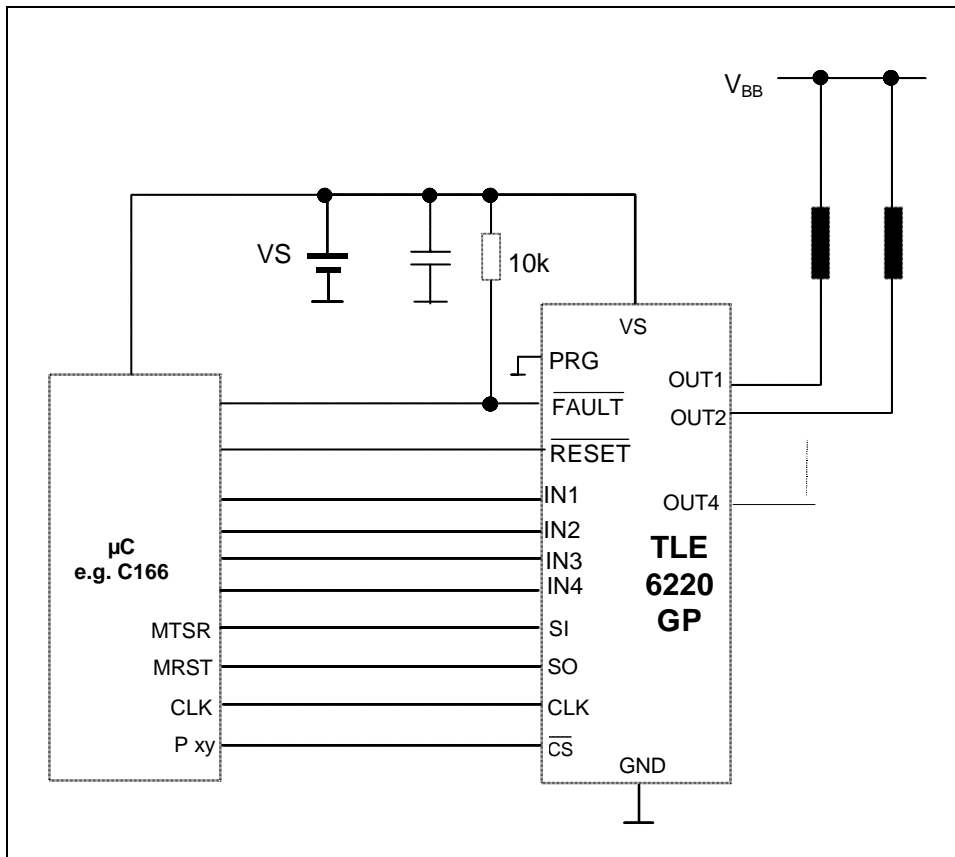


Figure 5: Power Outputs

### Application Circuit



## Typical electrical Characteristics

### Drain-Source on-resistance

$$R_{DS(ON)} = f(T_j) ; V_s = 5V$$

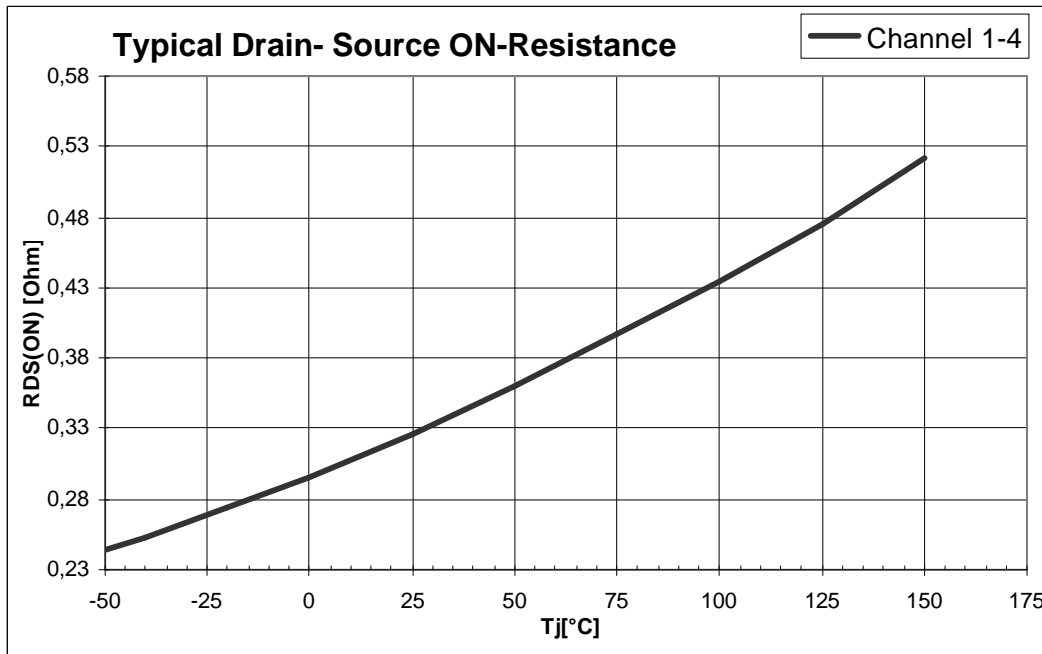


Figure 6 : Typical ON Resistance versus Junction-Temperature  
Channel 1-4

### Output Clamping Voltage

$$V_{DS(AZ)} = f(T_j) ; V_s = 5V$$

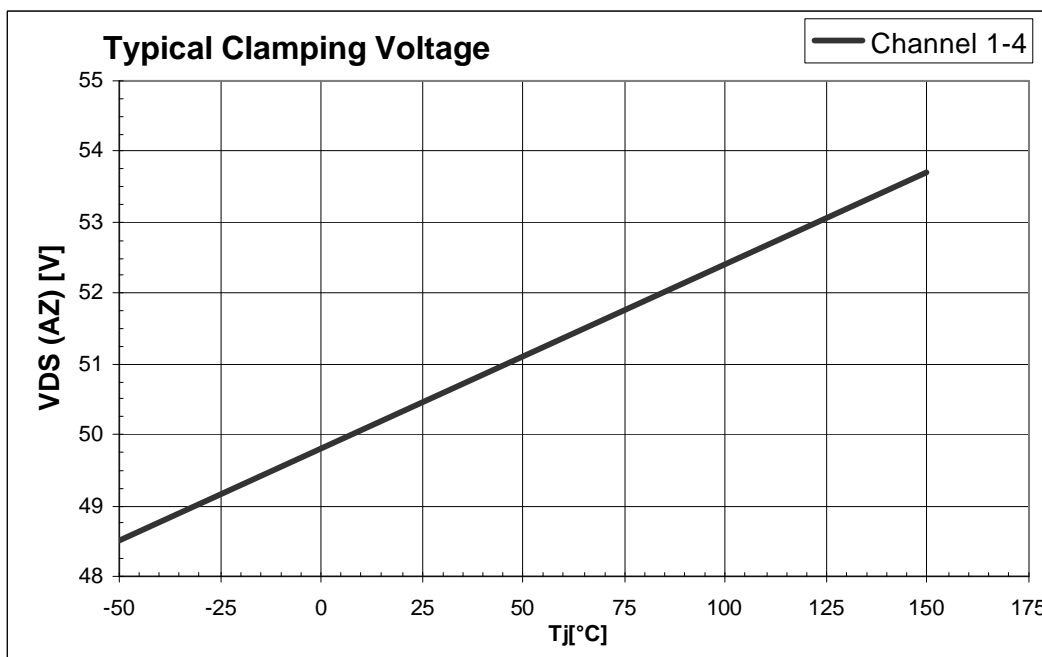
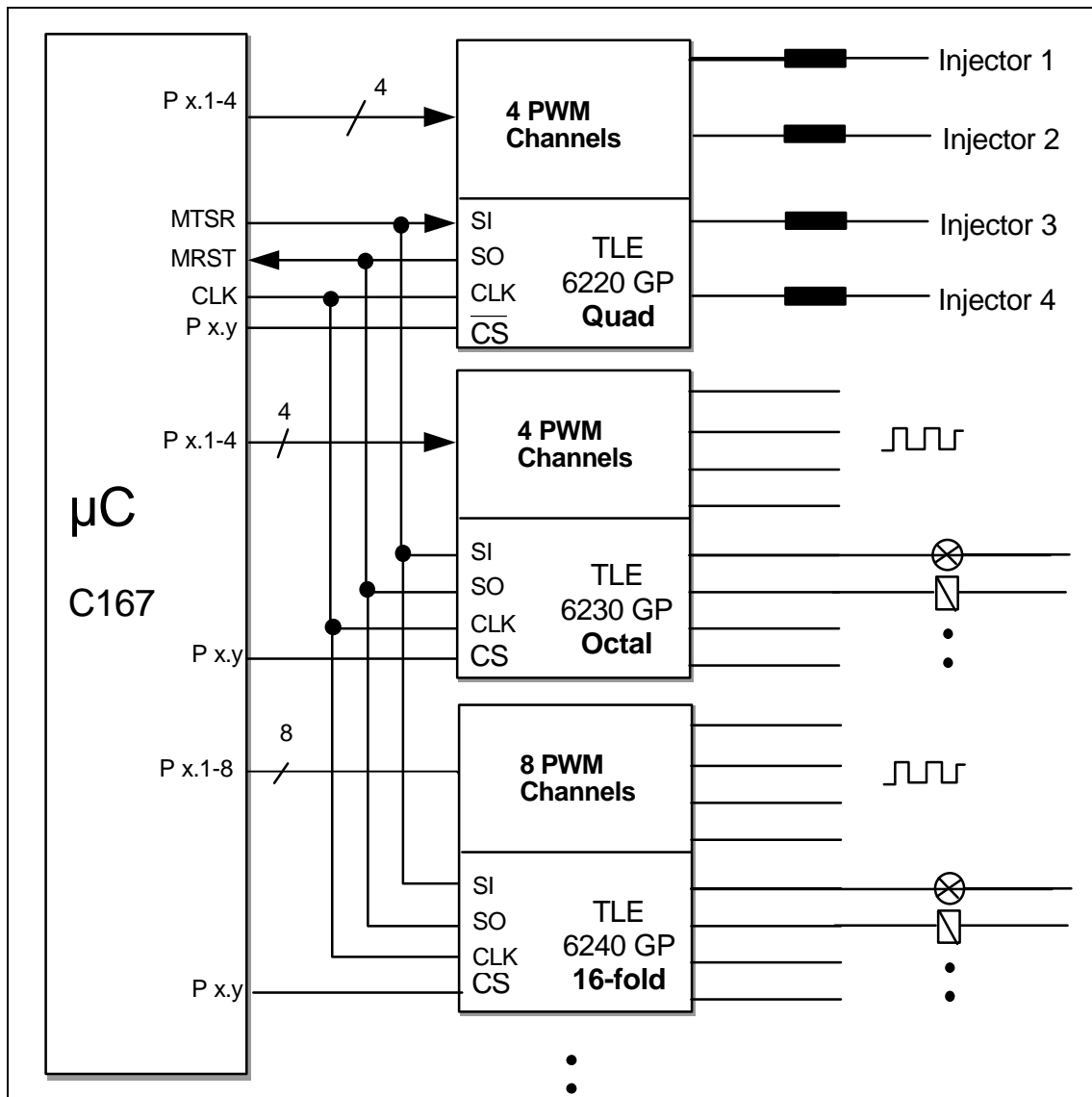


Figure 7 : Typical Clamp Voltage versus Junction-Temperature  
Channel 1-4

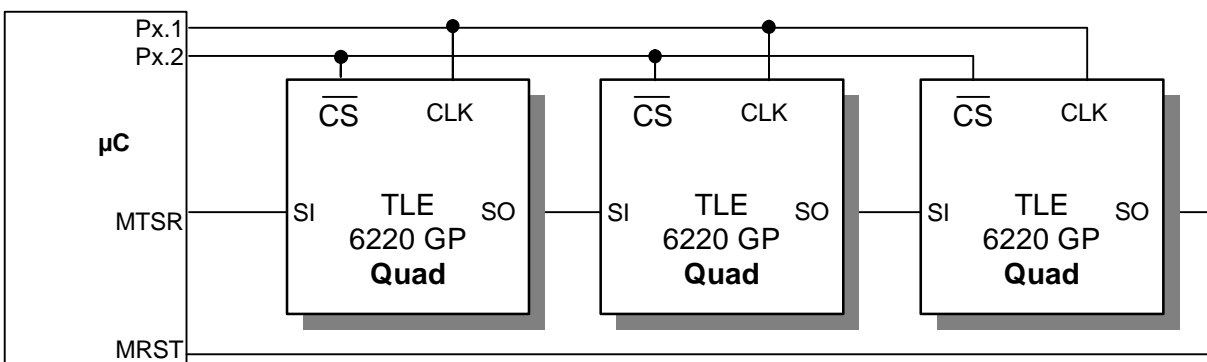
## Parallel SPI Configuration

### Engine Management Application

TLE 6230 GP in combination with TLE 6240 GP (16-fold switch) for relays and general purpose loads and TLE 6220 GP (quad switch) to drive the injector valves. This arrangement covers the numerous loads to be driven in a modern Engine Management/Powertrain system. From 28 channels in sum 16 can be controlled direct in parallel for PWM applications.



### Daisy Chain Application TLE 6220 GP

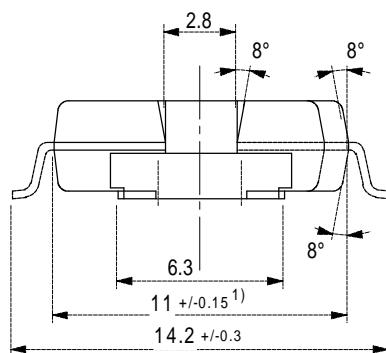
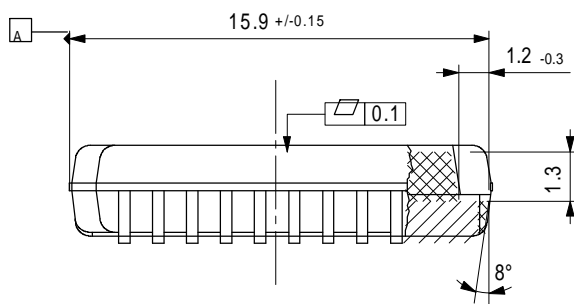
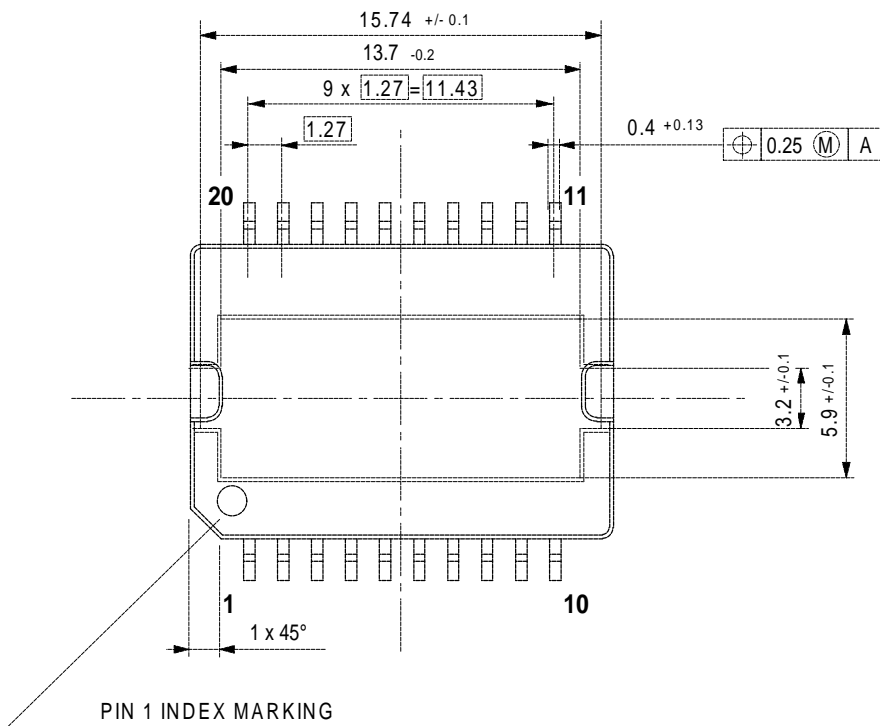


## Package and Ordering Code

(all dimensions in mm)

PG - DSO - 20

TLE 6220 GP



**Green Product (RoHS compliant)**

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

## Revision History

| Version         | Date       | Changes  |
|-----------------|------------|--|
| V2.1 -><br>V2.2 | 18.11.2009 | Package changed to PG-DSO-20<br>Ordering code removed  |
| V2.0 -><br>V2.1 | 20.04.2007 | Ordering Code removed<br>Layout Changes<br>Correct green package name implemented P-DSO-20-12 → PG-DSO-20-26   |
| V1.1 -><br>V2.0 | 20.05.2003 | Changes to Green Product Version: <ul style="list-style-type: none"> <li>- AEC, RoHS Logo and Feature List content added</li> <li>- Package Name P-DSO -&gt; PGDSO</li> <li>- Change History added</li> <li>- Disclaimer re-newed</li> </ul> |
| V1.1            | 28.08.2007 | Initial Version of "grey" product  |

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